

MOSFETs Silicon N-channel MOS (U-MOSIV)

TPCP8011

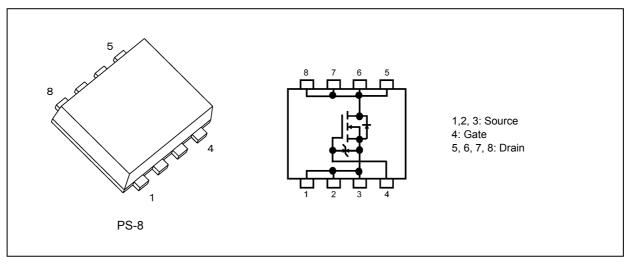
1. Applications

- · Motor Drivers
- Mobile Equipment

2. Features

- (1) AEC-Q101 qualified
- (2) Small, thin package
- (3) Small gate charge : $Q_{SW} = 4.7 \text{ nC (typ.)}$
- (4) Low drain-source on-resistance: $R_{DS(ON)} = 25.5 \text{ m}\Omega$ (typ.) ($V_{GS} = 10 \text{ V}$)
- (5) Low leakage current: $I_{\rm DSS}$ = 10 μA (max) (V_{DS} = 40 V)
- (6) Enhancement mode: $V_{th} = 2$ to 3 V ($V_{DS} = 10$ V, $I_D = 1$ mA)

3. Packaging and Internal Circuit





4. Absolute Maximum Ratings (Note) (Ta = 25°C unless otherwise specified)

Characteris	Symbol	Rating	Unit		
Drain-source voltage			V_{DSS}	40	V
Gate-source voltage			V _{GSS}	±20	
Drain current (DC)		(Note 1)	I _D	5	Α
Drain current (pulsed)		(Note 1)	I _{DP}	20	
Power dissipation	(t = 5 s)	(Note 2)	P_D	1.96	W
Power dissipation	(t = 5 s)	(Note 3)	P_{D}	0.94	W
Single-pulse avalanche energy		(Note 4)	E _{AS}	33.2	mJ
Avalanche current			I _{AR}	5	Α
Channel temperature		(Note 5)	T _{ch}	175	°C
Storage temperature		(Note 5)	T _{stg}	-55 to 175	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

5. Thermal Characteristics

Characteristics	Symbol	Max	Unit		
Channel-to-ambient thermal resistance	(t = 5 s)	(Note 2)	R _{th(ch-a)}	76.5	°C/W
Channel-to-ambient thermal resistance	(t = 5 s)	(Note 3)	R _{th(ch-a)}	159.5	°C/W

Note 1: Ensure that the channel temperature does not exceed 175°C.

Note 2: Device mounted on a glass-epoxy board (a), Figure 5.1

Note 3: Device mounted on a glass-epoxy board (b), Figure 5.2

Note 4: V_{DD} = 25 V, T_{ch} = 25°C (initial), L = 1.379 mH, R_G = 1 Ω , I_{AR} = 5 A

Note 5: The definitions of the absolute maximum channel and storage temperatures are qualified per AEC-Q101.

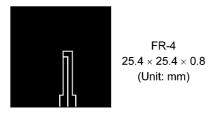


Fig. 5.1 Device Mounted on a Glass-Epoxy Board (a)

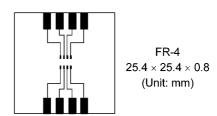


Fig. 5.2 Device Mounted on a Glass-Epoxy Board (b)

Note: This transistor is sensitive to electrostatic discharge and should be handled with care.



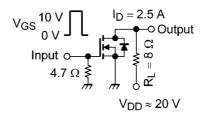
6. Electrical Characteristics

6.1. Static Characteristics (T_a = 25°C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current	I _{GSS}	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±10	μА
Drain cut-off current	I _{DSS}	V _{DS} = 40 V, V _{GS} = 0 V	_	_	10	
Drain-source breakdown voltage	V _{(BR)DSS}	I _D = 10 mA, V _{GS} = 0 V	40			V
Drain-source breakdown voltage	V _{(BR)DSX}	I _D = 10 mA, V _{GS} = -20 V	20	_		
Gate threshold voltage	V_{th}	V _{DS} = 10 V, I _D = 1 mA	2	2.5	3	
Drain-source on-resistance	R _{DS(ON)}	V _{GS} = 6 V, I _D = 2.5 A	_	32	51.2	mΩ
		V _{GS} = 10 V, I _D = 2.5 A	_	25.5	31.8	

6.2. Dynamic Characteristics (T_a = 25°C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Input capacitance	C _{iss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz	_	505	_	pF
Reverse transfer capacitance	C _{rss}		_	66	_	
Output capacitance	C _{oss}		_	115	_	
Switching time (rise time)	t _r	See Figure 6.2.1	_	5.37	_	ns
Switching time (turn-on time)	t _{on}		_	12	_	
Switching time (fall time)	t _f		_	4.34	_	
Switching time (turn-off time)	t _{off}		_	17.4	_	



Duty \leq 1%, $t_{\text{W}} =$ 10 μs

Fig. 6.2.1 Switching Time Test Circuit

6.3. Gate Charge Characteristics (T_a = 25°C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Total gate charge (gate-source plus gate-drain)	Q_g	$V_{DD} \approx 32 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 5 \text{ A}$	_	11.8		nC
Gate-source charge 1	Q _{gs1}			2.1		
Gate-drain charge	Q_{gd}		_	3.9	_	
Gate switch charge	Q_{SW}		_	4.7	_	

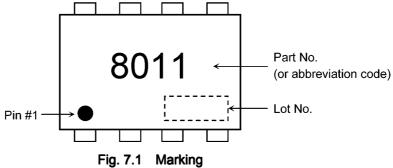
6.4. Source-Drain Characteristics (T_a = 25°C unless otherwise specified)

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Reverse drain current (pulsed)	(Note 6)	I _{DRP}	_	_	_	20	Α
Diode forward voltage		V_{DSF}	I _{DR} = 5 A, V _{GS} = 0 V			-1.2	V

Note 6: Ensure that the channel temperature does not exceed 175°C.



7. Marking



8. Characteristics Curves (Note)

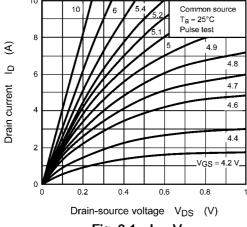


Fig. 8.1 I_D - V_{DS}

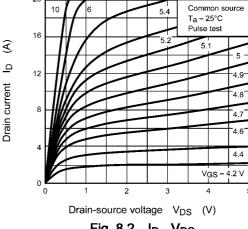


Fig. 8.2 I_D - V_{DS}

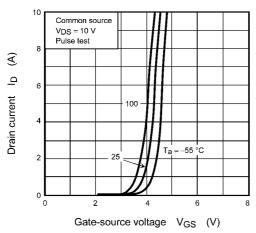


Fig. 8.3 I_D - V_{GS}

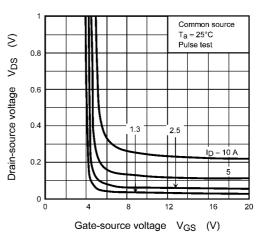


Fig. 8.4 V_{DS} - V_{GS}

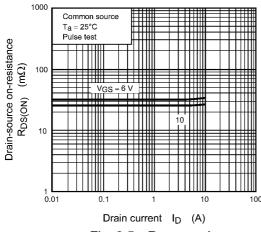


Fig. 8.5 R_{DS(ON)} - I_D

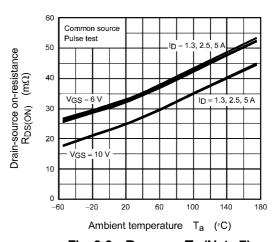


Fig. 8.6 R_{DS(ON)} - T_a (Note 7)

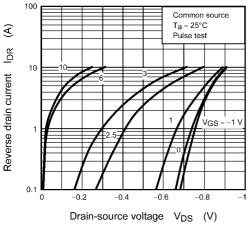


Fig. 8.7 IDR - VDS

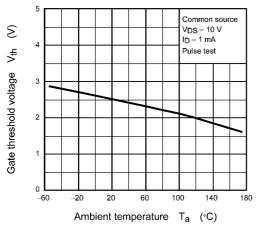


Fig. 8.9 V_{th} - T_a (Note 7)

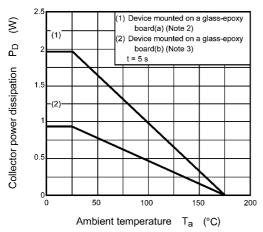


Fig. 8.11 P_D - T_a (Note 7) (Guaranteed Maximum)

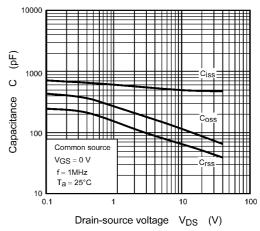


Fig. 8.8 Capacitance - V_{DS}

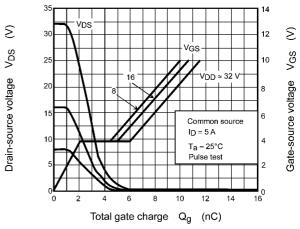


Fig. 8.10 Dynamic Input/Output Characteristics

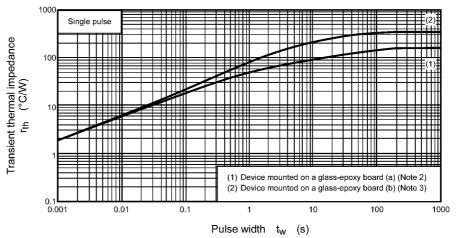


Fig. 8.12 r_{th} - t_w (Guaranteed Maximum)

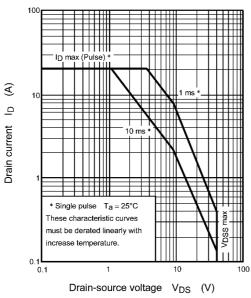


Fig. 8.13 Safe Operating Area (Guaranteed Maximum)

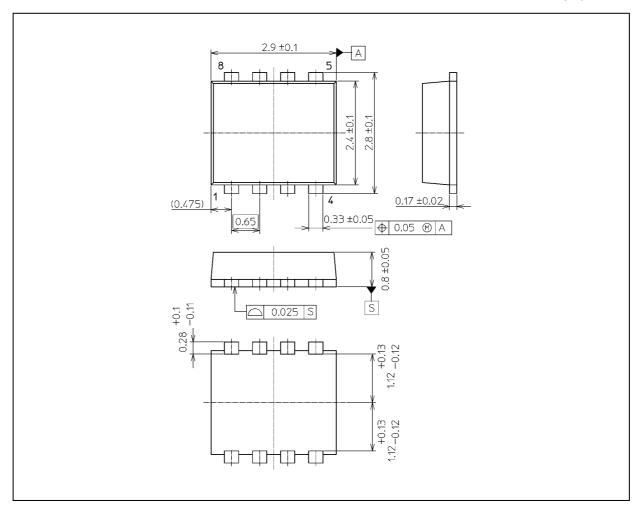
Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

Note 7: The definitions of the absolute maximum channel and storage temperatures are qualified per AEC-Q101.



Package Dimensions

Unit: mm



Weight: 0.017 g (typ.)

	Package Name(s)	
TOSHIBA: 2-3V1S		
Nickname: PS-8		



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